Technical Specifications of Semiconductor Parameter Analyzer

1.0 Bidder Eligibility Criteria-I

SI.	Bidder Eligibility Criteria-I	Complied	Reference	Remarks, If
No		/ Not	Page No.	any
		Complied		
1	The bidder/OEM should have supplied at least 2 similar items to IITs,			
	NITs, IISERs, CSIR Labs or other Govt. R&D organizations in the			
	last 5 years, PO copies or installation certificates along with contact			
	details of end user need to be submitted as the proof of supply. IIT			
	Madras reserves its right to verify the claims submitted by the bidder			
	and the feedback from the previous customers will be part of technical			
	evaluation.			

2.0 Technical Specifications II

Sr. No	Unit			Specifications		No.	Complied / Not Complied	Ref, Page No.
1		Paramete r		Source	Measure			
	Medium Power SMUs (Power delivery 2W or more) (i) Medium Power <u>High</u> <u>resolution</u> SMU	Current	Min •	±10 pA (or lower) with a resolution of 5fA.	±10 pA (or lower) with a resolution of 1fA.			
			Ma x	at least ±100 mA (or higher) with a resolution of 5µA.	at least ±100 mA (or higher) with a resolution of 100 nA.	2		
		Voltage	Min	± 500 mV (or lower) with a resolution of 25μ V (or better).	$\pm 500 \text{mV}$ (or lower) with a resolution of 0.5 μ V (or better).			
			Ma x	at least ±200V (or higher) with a resolution of 5	±200V (or higher) with a resolution of 200			

				mV.	μV or better.		
		Current	Min	At least ±100 nA (or lower) with a resolution of 5 pA, or better.	At least ± 100 nA (or lower) with a resolution of 100 fA, or better.		
			Ma x	± 100 mA (or higher) with a resolution of 5 μ A, or better.	±100 mA (or higher) with a resolution of 100 nA, or better.	2	
	(ii) Medium Power SMU	Voltage	Min	$\pm 500 \text{ mV}$ (or lower) with a resolution of $25\mu V$ (or better).	\pm 500mV (or lower) with a resolution of 0.5 μ V (or better).		
			Ma x	at least ±200V (or higher) with a resolution of 5 mV.	$\pm 200V$ (or higher) with a resolution of 200 μV or better.		
		• All SM	U sho	uld provide voltag	ge/current in Bias;		
		Common; Sweep; List sweep (custom point-by-point					
		user-defined sweep); Step mode.					
			• SMU should able to apply pulse in ms range.				
2	Ground Unit	A separate ground unit (not occupying any of the 9 slots) must be available with at least 4A sink current.					
	Pulse generator /fast	For pulse stress characterizations, Flash memory characterizations and NBTI, PBTI measurements.					
3	measureme nt		No. of channels: 2 (with the ability to obtain synchronized or independent fast current and voltage (I-V) measurements)			1	
	/waveform generator unit	Frequency higher).	Frequency range: at least 1Hz (or lower) to 30 MHz (or				
		• Voltage amplitude range: Up to ± 40 V or more for					
		 source and measure. Current range: 100nA (or smaller) to 10mA (or higher) for fast IV measurement. 					
		Pulse period programmable: from at least 20 ns to higher.					
		Pulse width programmable: Should be able to offer a minimum pulse width of 70 ns @ 10V source.					
		Minimum Transition time: 20ns @ 10V range and 100 ns for higher voltage range. Sampling rate : 200 MS/s Programmable parameters: Pulse width, duty cycle, rise time, fall time, amplitude, offset. System should have built in current measurement facility.					

		System should have built in Capability to switch the	
4	SMU-	measurements from IV to Pulsed IV from select menu	
	PMU	without changing the connections on the DUT. Must provide	
	switching	the switching capability between two SMUs and the pulse	
	unit.	generator channels.	
-	L V Cause and	At least the following:	
5	I-V Sweep	1. single and double staircase sweep, pulsed sweep,	
	Mode with lab	staircase sweep with pulsed bias, I/V-t sampling: at	
	view controlled	least 4000 measurement points, or more	
	programs.	2. list sweep, linear and log interval, bias hold and	
		negative hold tim	
Otho	r General specificat	ionc:	
Othe	-		
~		convenient user interface preferably windows based.	
6	Interface for remo		
		upplied with the following interface and ports.	
		k, USB, LAN, trigger in/out, digital I/O	
		options: Touch panel, knob, soft keys, USB, keyboard and	
	mouse		
	The		
-	The instrument	Same software must be able to run on user computer to	
7	software/firmwa	control the instrument and perform measurements. Also	
	re must have both offline and	software must be able to run on user computer for offline setup and analysis of collected data. The software/firmware	
	online	must be capable to control the instrument from external PC.	
	capability.	must be capable to control the instrument from external FC.	
	Must have	For testing FETs, Flash memory, NBTI/PBTI, BJTs, diodes,	
8	readymade	etc, System should have feasibility to write different	
U	setups for most	customized test routine for hardware configuration. System	
	commonly used	should have facility to modify or write user test modules.	
	devices.	should have facility to modify of write user test modules.	
	Sequencing	Must have the capability to sequence multiple tests without	
9	bequeiteing	any programming effort.	
	Must have canabili	ty to sweep the source enabling real time device	
10	characterization.	ty to sweep the source enabling real time device	
10		LICD nort to cofely take the date out of the instrument	
11	System should hav	e USB port to safely take the data out of the instrument.	
11			
10	Control from	built-in graphical programming environment	
12	Remote PC		
4.0	Support:	The equipment should be compatible with:	
13	Device	a. device modeling software	
	modeling	b. network analyzer,	
	software,	c. Must be able to control standard prober system,	
	instruments,	including but not limited to probe stations from Ever	
	and prober	Being, Cascade, Form Factor, Lakeshore, Jenis, etc,.	
	•	-	
14	Future		
	Upgradability	-	
	• • •		
14	and prober Future	 Being, Cascade, Form Factor, Lakeshore, Jenis, etc,. System should be upgradable to: 1. high current device measurement (at least 40 A, or higher). 	

15		The following cables (supporting low current measurements at least below 1 pA) should be supplied.		
		Triaxial cables: 1.5 m length	10	
		Coaxial cables: at least 3-m-length, or longer	10	
	Cables	GPI cable of at least 2-m-length	2	
16		 The following connectors (supporting low current measurements, at least below 1 pA) should be supplied. i. Triax to BNC connectors: 1. Triax (M) to BNC (F) connectors 	5	
		1. Triax (F) to BNC (M) connectors	10	
	Adaptors/ Connectors	2. Triax (F) to BNC (F) connectors	5	
	Connectors	ii. BNC tee connectors	10	
		iii. Banana connectors (Banana to alligator)	10	
17	Other adaptors / connectors	Supplier should provide all kinds of adaptors/connectors and cables required to use all features of the system.		
	Warranty	Service and warranty for a minimum period of three years for the equipment must be provided.		
18				
19	Optional	 Multi-frequency C-V measurement unit <u>C-V measurement test signal:</u> 	1	
		 Frequency: 1 kHz to 5 MHz (or higher) frequency range with minimum 1 kHz frequency resolution. 		
		 <u>AC amplitude</u> Range: at least 10 mV (or lower) to 100 mV (or higher): rms Resolution: at least 1 mV (rms), or better (higher resolution) 		
		 DC bias: Range: at least range -25 V to +25V, or higher Resolution: at least 1 mV, or better (higher resolution) 		
		Measurement parameters; CP–G, CP–D, CS–RS, CS–D, R–jX, Z-theta, Y-theta Optional: Cp-Q, Cs-Q, Lp-G, Lp-D, Lp-Q, Lp-Rp, Ls- Rs, Ls-D, Ls-Q, R-X, G-B, Z-q, Y-q		
		 Sweep Characteristics: AC voltage, DC bias voltage, frequency Sweep type: Linear, custom Sweep direction: Up sweep, down sweep 		
		2. SMU- PMU- CVU switching unit- System should have built in Capability to switch the measurements		

	from IV, CV to Pulsed IV from select menu without changing the connections on the DUT. Must provide the switching capability between two SMUs and the pulse generator channels.	1					
Othe	Other Terms and Conditions						
1	Compliance sheet for the technical specification and OEM Brochure have to be attached along with the Technical bid. Vendor has to fill the compliance sheet and mention page number or reference number in OEM brochure. Unfilled/partially filled sheets may lead to disqualification.						
2	The bidder should be either an Original Equipment Manufacturer (OEM) of semiconductor parameter analyzer or should be an authorized representative (provide documentary proof) of an OEM.						

Gene	General Terms and Conditions					
1.	The Semiconductor Device Parameter Analyzer should have:					
2.	4 Medium Power Source Measure Units (MPSMUs), out of which at least 2 SMUs should be of high resolution type (capable to measure minimum current of 10pA with a resolution of 1fA).					
3.	1 Pulse generator/pulse measure/Fast measurement unit.					
4.	An upgradability and support of at least 9 slot modules, or more and must allow upgrading with more SMUs if empty slots are available.					
5.	System should have Kelvin connection at GND unit.					
6.	Ground unit with at least ± 4 A sink current, or higher					
7.	Must have a inbuilt touch screen display					
8.	The setup must be upgradable to be used for high power device characterization in future up to 3kV and 1500A.					
9.	Must include necessary number of all kinds of connectors to connect various part of the system to other ports and 1.5m cables for connections.					
10.	The capability to connect to standard probe stations, including but not limited to probe stations from, Ever Being, Cascade, Lakeshore, Jenis, etc,					

(Note: It is mandatory for the bidders to provide the compliance statement in tabular column format along with catalogue page number (comply/not comply) for the Above points with document proof as required. Failing which bidders will be technically disqualified)